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# **ON Semiconductor**®

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#### Features

- Maximum Junction Temperature : T<sub>J</sub> =175<sup>o</sup>C
- · Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: V<sub>CE(sat)</sub> =1.6 V(Typ.) @ I<sub>C</sub> = 40 A
- + 100% of the Parts Tested for  $I_{LM}(1)$
- · High Input Impedance
- Fast Switching
- Tighten Parameter Distribution
- · RoHS Compliant

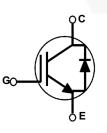
### **General Description**

Using novel field stop IGBT technology, Fairchild's new series of field stop 3<sup>rd</sup> generation IGBTs offer the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction and switching losses are essential.

#### Applications

• Solar Inverter, UPS, Welder, Telecom, ESS, PFC





#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Description		FGH40T65SHD_F155	Unit	
V <sub>CES</sub>	Collector to Emitter Voltage		650	V	
V <sub>GES</sub>	Gate to Emitter Voltage		± 20	V	
♥ GES	Transient Gate to Emitter Voltage		± 30	V	
	Collector Current	@ T <sub>C</sub> = 25 <sup>o</sup> C	80	А	
IC	Collector Current	@ T <sub>C</sub> = 100 <sup>o</sup> C	40	А	
I <sub>LM (1)</sub>	Pulsed Collector Current	@ T <sub>C</sub> = 25°C	120	А	
I <sub>CM (2)</sub>	Pulsed Collector Current		120	А	
1_	Diode Forward Current	@ T <sub>C</sub> = 25 <sup>o</sup> C	40	А	
I <sub>F</sub>	Diode Forward Current	@ T <sub>C</sub> = 100°C	20	А	
I <sub>FM (2)</sub>	Pulsed Diode Maximum Forward Curren	120	А		
P <sub>D</sub>	Maximum Power Dissipation	@ T <sub>C</sub> = 25 <sup>o</sup> C	268	W	
' D	Maximum Power Dissipation	@ T <sub>C</sub> = 100°C	134	W	
TJ	Operating Junction Temperature		-55 to +175	°C	
T <sub>stg</sub>	Storage Temperature Range		-55 to +175	°C	
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

Notes:

1.  $V_{CC}$  = 400 V,  $V_{GE}$  = 15 V, I\_C =120 A, R\_G = 30  $\Omega,$  Inductive Load

2. Repetitive rating: Pulse width limited by max. junction temperature

April 2015

### Thermal Characteristics

Symbol	Parameter	FGH40T65SHD_F155	Unit	
R <sub>0JC</sub> (IGBT)	Thermal Resistance, Junction to Case, Max.	0.56	°C/W	
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case, Max.	1.71	°C/W	
R <sub>0JA</sub>	Thermal Resistance, Junction to Ambient, Max.	40	°C/W	

### Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGH40T65SHD_F155	FGH40T65SHD	TO-247 G03	Tube	-	-	30

### Electrical Characteristics of the IGBT T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics					
BV <sub>CES</sub>	Collector to Emitter Breakdown Voltage	V <sub>GE</sub> = 0V, I <sub>C</sub> = 1 mA	650	-	-	V
ΔBV <sub>CES</sub> / ΔT <sub>J</sub>	Temperature Coefficient of Breakdown Voltage	$I_{\rm C}$ = 1 mA, Reference to 25°C	-	0.6	-	V/ºC
I <sub>CES</sub>	Collector Cut-Off Current	V <sub>CE</sub> = V <sub>CES</sub> , V <sub>GE</sub> = 0 V	-	-	250	μA
I <sub>GES</sub>	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
On Charac	teristics					
V <sub>GE(th)</sub>	G-E Threshold Voltage	$I_{\rm C}$ = 40 mA, $V_{\rm CE}$ = $V_{\rm GE}$	4.0	5.5	7.5	V
OE(III)	5	$I_{\rm C} = 40$ A, $V_{\rm GE} = 15$ V	-	1.6	2.1	V
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage	$I_{C} = 40 \text{ A}, V_{GE} = 15 \text{ V},$ $T_{C} = 175^{\circ}\text{C}$	-	2.14	-	V
Dynamic C	Characteristics					
C <sub>ies</sub>	Input Capacitance		-	1995	-	pF
C <sub>oes</sub>	Output Capacitance	$V_{CE} = 30 V_{V_{GE}} = 0 V_{V_{GE}}$	-	70	-	pF
C <sub>res</sub>	Reverse Transfer Capacitance	f = 1MHz	-	23	-	pF
Switching	Characteristics			1		
t <sub>d(on)</sub>	Turn-On Delay Time		-	19.2	- /	ns
t <sub>r</sub>	Rise Time		-	34.4	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>CC</sub> = 400 V, I <sub>C</sub> = 40 A,	-	65.6	-	ns
t <sub>f</sub>	Fall Time	R <sub>G</sub> = 6 Ω, V <sub>GE</sub> = 15 V,	-	9.6		ns
Eon	Turn-On Switching Loss	Inductive Load, $T_C = 25^{\circ}C$	-	1010	-	uJ
E <sub>off</sub>	Turn-Off Switching Loss		-	297	-	uJ
E <sub>ts</sub>	Total Switching Loss		-	1307	-	uJ
t <sub>d(on)</sub>	Turn-On Delay Time		-	18.4	-	ns
t <sub>r</sub>	Rise Time		-	32.8	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{CC} = 400 \text{ V}, I_C = 40 \text{ A},$ $R_G = 6 \Omega, V_{GE} = 15 \text{ V},$ Inductive Load, $T_C = 175^{\circ}C$	-	71.2	-	ns
t <sub>f</sub>	Fall Time		-	14.4	-	ns
	Turn-On Switching Loss		-	1390	-	uJ
Eon	1 a o o					
E <sub>on</sub> E <sub>off</sub>	Turn-Off Switching Loss	-	-	541	-	uJ

### Electrical Characteristics of the IGBT (Continued)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max	Unit
Qg	Total Gate Charge	V <sub>CE</sub> = 400 V, I <sub>C</sub> = 40 A, V <sub>GE</sub> = 15 V	-	72.2	-	nC
Q <sub>ge</sub>	Gate to Emitter Charge		-	13.5	-	nC
Q <sub>gc</sub>	Gate to Collector Charge		-	28.5	-	nC

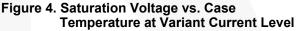
### Electrical Characteristics of the Diode T<sub>C</sub> = 25°C unless otherwise noted

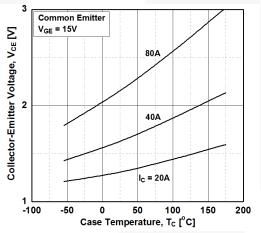
Symbol	Parameter	Test Conditio	ons	Min.	Тур.	Мах	Unit
V <sub>FM</sub>	Diode Forward Voltage	I <sub>F</sub> = 20 A	T <sub>C</sub> = 25 <sup>o</sup> C	-	2.2	2.8	V
			T <sub>C</sub> = 175 <sup>o</sup> C	-	1.94	-	
E <sub>rec</sub>	Reverse Recovery Energy		T <sub>C</sub> = 175 <sup>o</sup> C	-	50	-	uJ
t <sub>rr</sub> Diode Reverse Recovery Time	Diode Reverse Recovery Time	I <sub>F</sub> =20 A, dI <sub>F</sub> /dt = 200 A/μs	T <sub>C</sub> = 25 <sup>o</sup> C	-	31.8	-	ns
	$  _{F} = 20 \text{ A}, \text{ alp/at} = 200 \text{ A/}\mu\text{S}$	T <sub>C</sub> = 175°C	-	192	-		
Q <sub>rr</sub>	Q <sub>rr</sub> Diode Reverse Recovery Charge		T <sub>C</sub> = 25°C	-	50.6	-	nC
<b>u</b> n	Diodo Hoveroo Hooovery enarge		T <sub>C</sub> = 175 <sup>o</sup> C	-	699		

#### **Typical Performance Characteristics Figure 1. Typical Output Characteristics** 120 120 $T_C = 25^{\circ}C$ 20V T<sub>C</sub> = 175°C 15V 90 Collector Current, Ic [A] Collector Current, I<sub>c</sub> [A] 90 10V 60 60 V<sub>GE</sub> = 8V 30 30 0 0 1 2 3 4 Collector-Emitter Voltage, V<sub>CE</sub> [V] 5 0 0 Figure 3. Typical Saturation Voltage Characteristics 120 3 Common Emitter Collector-Emitter Voltage, V<sub>CE</sub> [V] V<sub>GE</sub> = 15V $T_{C} = 25^{\circ}C$ — Collector Current, I<sub>c</sub> [A] 90 T<sub>C</sub> = 175<sup>°</sup>C .... 60 2 30 0 -100 0 2 3 4 -50 Collector-Emitter Voltage, V<sub>CE</sub> [V] Figure 5. Saturation Voltage vs. V<sub>GE</sub> 20 20 Common Emitter $T_c = 25^{\circ}C$ Collector-Emitter Voltage, V<sub>CE</sub> [V] 16 12 I<sub>C</sub> = 20A 40A 8 80A

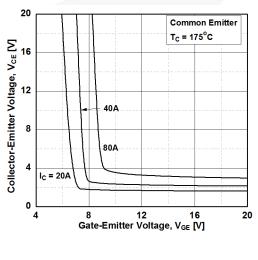
#### Figure 2. Typical Output Characteristics

20V









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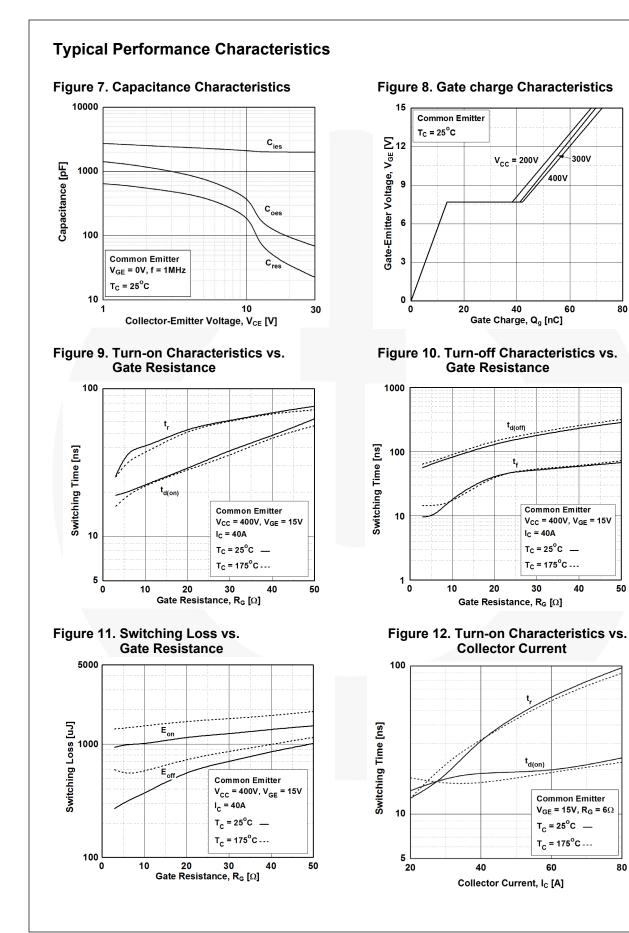
8 12 16 Gate-Emitter Voltage, V<sub>GE</sub> [V]

0 ∟ 4

20

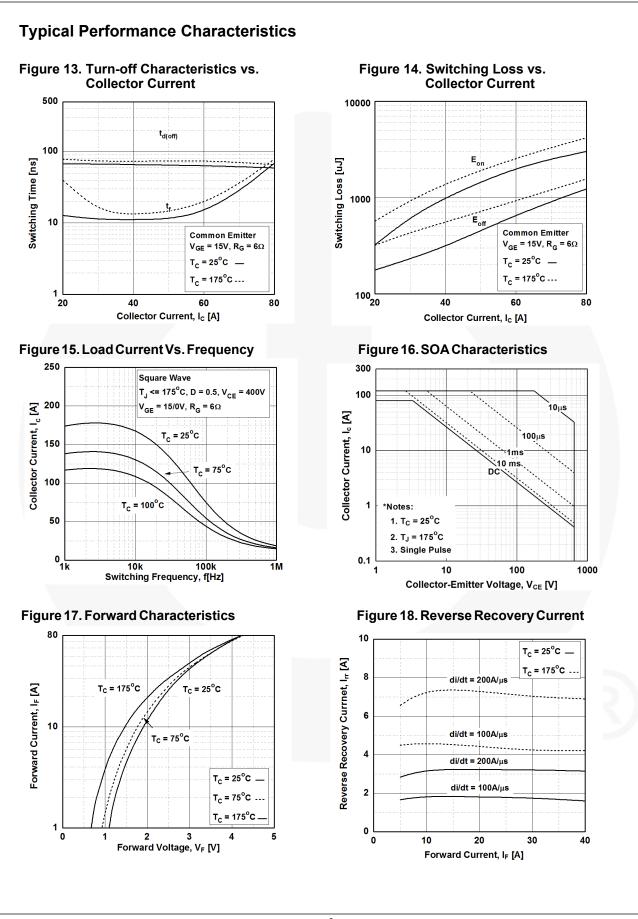
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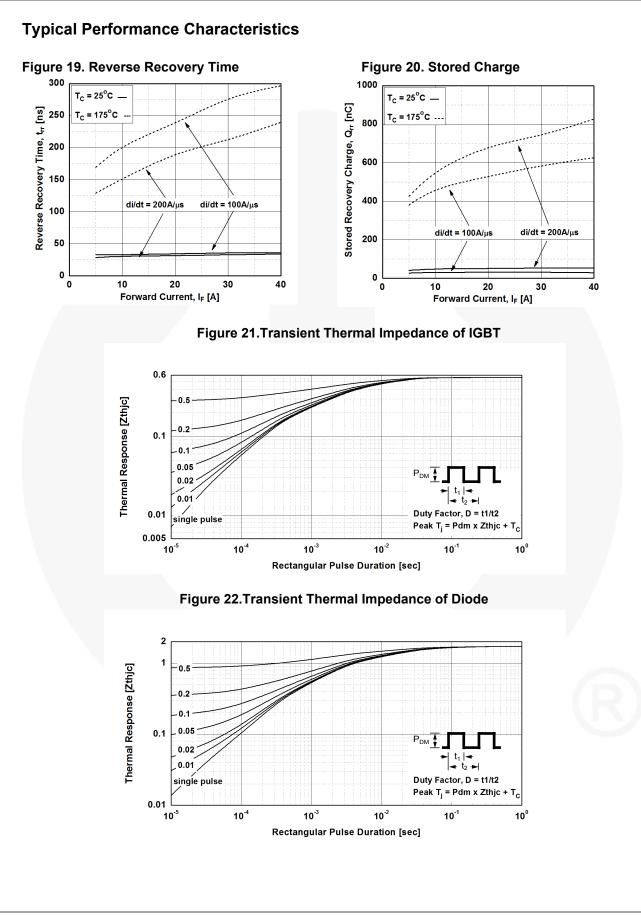


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